

TPS3890-Q1

Low Quiescent Current, 1% Accurate Supervisor with Programmable Delay

1 Features

- Qualified for Automotive Applications
- AEC-Q100 Qualified With the Following Results:
 - Device Temperature Grade 1: -40°C to 125°C Ambient Operating Temperature Range
 - Device HBM ESD Classification Level 2
 - Device CDM ESD Classification Level C4B
- Power-On-Reset (POR) Generator with Adjustable Delay Time: 25 μ s to 30 s
- Very Low Supply Current: 2.1 μ A (Typical)
- High Threshold Accuracy: 1% (max)
- Precision Hysteresis
- Fixed and Adjustable Threshold Voltages:
 - Fixed Thresholds for Standard Rails: 1.2 V to 5 V
 - Adjustable Down to 1.15 V
- Manual Reset ($\overline{\text{MR}}$) Input
- Open-Drain $\overline{\text{RESET}}$ Output
- Temperature Range: -40°C to +125°C
- Package: 1.5-mm $\times$ 1.5-mm WSON

2 Applications

- Infotainment Head Unit
- Hybrid/Digital Cluster
- External Amplifier
- ADAS Camera
- Automotive Gateway

3 Description

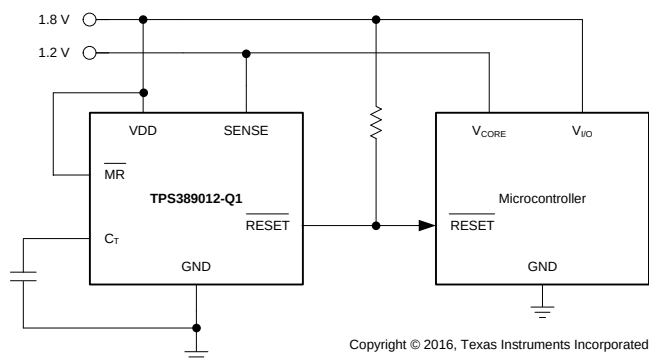
The TPS3890-Q1 is a precision voltage supervisor with low-quiescent current that monitors system voltages as low as 1.15 V, asserting an open-drain $\overline{\text{RESET}}$ signal when the SENSE voltage drops below a preset threshold or when the manual reset ($\overline{\text{MR}}$) pin drops to a logic low. The $\overline{\text{RESET}}$ output remains low for the user-adjustable delay time after the SENSE voltage and manual reset ($\overline{\text{MR}}$) return above the respective thresholds. The TPS3890-Q1 family uses a precision reference to achieve 1% threshold accuracy. The reset delay time can be user-adjusted between 25 μ s and 30 s by connecting the CT pin to an external capacitor. The TPS3890-Q1 has a very low quiescent current of 2.1 μ A and is available in a small 1.5-mm $\times$ 1.5-mm package, making the device well-suited for battery-powered and space-constrained applications. The device is fully specified over a temperature range of -40°C to +125°C (T_J).

Device Information⁽¹⁾

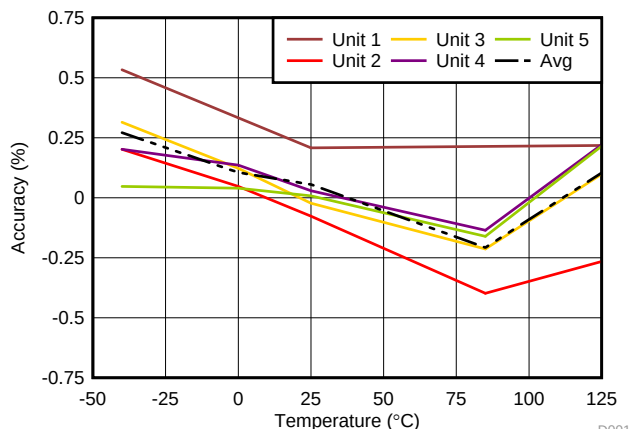
PART NUMBER	PACKAGE	BODY SIZE (NOM)
TPS3890-Q1	WSON (6)	1.50 mm $\times$ 1.50 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Typical Application Circuit



V_{ITN} Accuracy vs Temperature



D001



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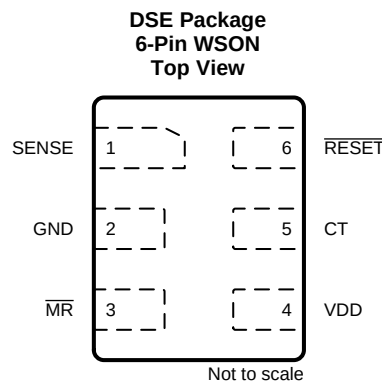
4 Revision History

Changes from Revision A (October 2017) to Revision B	Page
• Added Automotive features	1
• Added new voltage options to Device Comparison Table.....	3
Changes from Original (March 2017) to Revision A	Page
• Added TPS389050L-Q1 to Device Comparison Table	3

5 Device Comparison Table

PART NUMBER	NOMINAL SUPPLY VOLTAGE	NEGATIVE THRESHOLD (V_{ITN})	POSITIVE THRESHOLD (V_{ITP})
TPS389001-Q1	Adjustable	1.15 V	1.157 V
TPS389012-Q1	1.2 V	1.15 V	1.157 V
TPS389015-Q1	1.5 V	1.44 V	1.449 V
TPS389018-Q1	1.8 V	1.73 V	1.740 V
TPS389025-Q1	2.5 V	2.40 V	2.414 V
TPS389030-Q1	3.0 V	2.89 V	2.907 V
TPS389033-Q1	3.3 V	3.17 V	3.189 V
TPS389033G-Q1	3.3 V	3.06 V	3.084 V
TPS389033K-Q1	3.3 V	2.93 V	2.947 V
TPS389050-Q1	5.0 V	4.80 V	4.828 V
TPS389050G-Q1	5.0 V	4.65 V	4.677 V
TPS389050L-Q1	5.0 V	4.40 V	4.425 V

6 Pin Configuration and Functions



Pin Functions

PIN		I/O	DESCRIPTION
NO.	NAME		
1	SENSE	I	This pin is connected to the voltage to be monitored. When the voltage on SENSE falls below the negative threshold voltage V_{ITN} , $\overline{\text{RESET}}$ goes low (asserts). When the voltage on SENSE rises above the positive threshold voltage V_{ITP} , $\overline{\text{RESET}}$ goes high (deasserts).
2	GND	—	Ground
3	$\overline{\text{MR}}$	I	Driving the manual reset pin ($\overline{\text{MR}}$) low causes $\overline{\text{RESET}}$ to go low (assert).
4	VDD	I	Supply voltage pin. Good analog design practice is to place a 0.1- μF ceramic capacitor close to this pin.
5	CT	—	The CT pin offers a user-adjustable delay time. Connecting this pin to a ground-referenced capacitor sets the $\overline{\text{RESET}}$ delay time to deassert. $t_{PD(f)} \text{ (sec)} = C_{CT} \text{ (}\mu\text{F)} \times 1.07 + 25 \mu\text{s (nom)}$.
6	$\overline{\text{RESET}}$	O	$\overline{\text{RESET}}$ is an open-drain output that is driven to a low-impedance state when either the $\overline{\text{MR}}$ pin is driven to a logic low or the monitored voltage on the SENSE pin is lower than the negative threshold voltage (V_{ITN}). $\overline{\text{RESET}}$ remains low (asserted) for the delay time period after both $\overline{\text{MR}}$ is set to a logic high and the SENSE input is above V_{ITP} . A pullup resistor from 10 k Ω to 1 M Ω should be used on this pin.

7 Specifications

7.1 Absolute Maximum Ratings

over operating junction temperature range (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
Voltage	VDD	−0.3	7	V
	SENSE	−0.3	7	
	RESET	−0.3	7	
	MR	−0.3	7	
	V _{CT}	−0.3	7	
Current	RESET	−20	20	mA
Temperature	Operating junction, T _J	−40	125	°C
	Operating ambient, T _A	−40	125	
	Storage, T _{stg}	−65	150	

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

		VALUE	UNIT
V _(ESD) Electrostatic discharge	Human-body model (HBM), per AEC Q100-002 ⁽¹⁾	±2000	V
	Charged-device model (CDM), per AEC Q100-011	±750	

- (1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
V _{DD}	Power-supply voltage	1.5		5.5	V
V _{SENSE}	SENSE voltage	0		5.5	V
V _{RESET}	RESET pin voltage	0		5.5	V
I _{RESET}	RESET pin current	−5		5	mA
C _{IN}	Input capacitor, VDD pin	0	0.1		μF
C _{CT}	Reset timeout capacitor, CT pin	0		26	μF
R _{PU}	Pullup resistor, RESET pin	1		1000	kΩ
T _J	Junction temperature (free-air temperature)	−40	25	125	°C

7.4 Thermal Information

THERMAL METRIC ⁽¹⁾		TPS3890-Q1	UNIT
		DSE (WSON)	
		6 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	321.3	°C/W
R _{θJC(top)}	Junction-to-case (top) thermal resistance	207.9	°C/W
R _{θJB}	Junction-to-board thermal resistance	281.5	°C/W
ψ _{JT}	Junction-to-top characterization parameter	42.4	°C/W
ψ _{JB}	Junction-to-board characterization parameter	284.8	°C/W
R _{θJC(bot)}	Junction-to-case (bottom) thermal resistance	142.3	°C/W

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

7.5 Electrical Characteristics

over the operating junction temperature range of -40°C to $+125^{\circ}\text{C}$ ($T_A = T_J$), $1.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, and $\overline{\text{MR}} = V_{DD}$ (unless otherwise noted); typical values are at $V_{DD} = 5.5\text{ V}$ and $T_J = 25^{\circ}\text{C}$

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{DD}	Input supply voltage		1.5		5.5	V
V_{POR}	Power-on-reset voltage	$V_{OL(max)} = 0.2\text{ V}$, $I_{RESET} = 15\text{ }\mu\text{A}$			0.8	V
I_{DD}	Supply current (into VDD pin)	$V_{DD} = 3.3\text{ V}$, $I_{RESET} = 0\text{ mA}$, $-40^{\circ}\text{C} < T_J < 85^{\circ}\text{C}$		2.09	3.72	μA
		$V_{DD} = 3.3\text{ V}$, $I_{RESET} = 0\text{ mA}$, $-40^{\circ}\text{C} < T_J < 105^{\circ}\text{C}$			4.5	
		$V_{DD} = 3.3\text{ V}$, $I_{RESET} = 0\text{ mA}$			5.8	
		$V_{DD} = 5.5\text{ V}$, $I_{RESET} = 0\text{ mA}$, $-40^{\circ}\text{C} < T_J < 85^{\circ}\text{C}$		2.29	4	
		$V_{DD} = 5.5\text{ V}$, $I_{RESET} = 0\text{ mA}$, $-40^{\circ}\text{C} < T_J < 105^{\circ}\text{C}$			5.2	
		$V_{DD} = 5.5\text{ V}$, $I_{RESET} = 0\text{ mA}$			6.5	
V_{ITN} , V_{ITP}	SENSE input threshold voltage accuracy		-1%	$\pm 0.5\%$	1%	
V_{HYST}	Hysteresis ⁽¹⁾		0.325%	0.575%	0.825%	
I_{SENSE}	Input current	$V_{SENSE} = 5\text{ V}$			8	μA
		$V_{SENSE} = 5\text{ V}$, TPS389001-Q1, TPS389012-Q1		10	100	nA
I_{CT}	CT pin charge current		0.90	1.15	1.35	μA
V_{CT}	CT pin comparator threshold voltage		1.17	1.23	1.29	V
R_{CT}	CT pin pulldown resistance	When $\overline{\text{RESET}}$ is deasserted		200		Ω
V_{IL}	Low-level input voltage ($\overline{\text{MR}}$ pin)			$0.25 \times V_{DD}$		V
V_{IH}	High-level output voltage		$0.7 \times V_{DD}$			V
V_{OL}	Low-level output voltage	$V_{DD} \geq 1.5\text{ V}$, $I_{RESET} = 0.4\text{ mA}$			0.25	V
		$V_{DD} \geq 2.7\text{ V}$, $I_{RESET} = 2\text{ mA}$			0.25	
		$V_{DD} \geq 4.5\text{ V}$, $I_{RESET} = 3\text{ mA}$			0.3	
$I_{LKG(OD)}$	Open-drain output leakage	High impedance, $V_{SENSE} = V_{RESET} = 5.5\text{ V}$			250	nA

(1) $V_{HYST} = [(V_{ITP} - V_{ITN}) / V_{ITN}] \times 100\%$.

7.6 Timing Requirements

over the operating junction temperature range of -40°C to $+125^{\circ}\text{C}$ ($T_A = T_J$), $1.5\text{ V} \leq V_{DD} \leq 5.5\text{ V}$, $\overline{\text{MR}} = V_{DD}$, and 5% input overdrive⁽¹⁾ (unless otherwise noted); typical values are at $V_{DD} = 5.5\text{ V}$ and $T_J = 25^{\circ}\text{C}$

		MIN	NOM	MAX	UNIT
$t_{PD(f)}$	SENSE (falling) to $\overline{\text{RESET}}$ propagation delay	$C_T = \text{open}$, $V_{DD} = 3.3\text{ V}$	18		μs
		$C_T = \text{open}$, $V_{DD} = 5.5\text{ V}$	8		
$t_{PD(r)}$	SENSE (rising) to $\overline{\text{RESET}}$ propagation delay	$C_T = \text{open}$, $V_{DD} = 3.3\text{ V}$	25		μs
$t_{GI(SENSE)}$	SENSE pin glitch immunity	$V_{DD} = 5.5\text{ V}$	9		μs
$t_{GI(MR)}$	$\overline{\text{MR}}$ pin glitch immunity	$V_{DD} = 5.5\text{ V}$	100		ns
t_{MRW}	$\overline{\text{MR}}$ pin pulse duration to assert $\overline{\text{RESET}}$	1			μs
$t_{d(MR)}$	$\overline{\text{MR}}$ pin low to out delay		250		ns
t_{STRT}	Startup delay		325		μs

(1) Overdrive = $| (V_{IN} / V_{THRESH} - 1) \times 100\% |$.

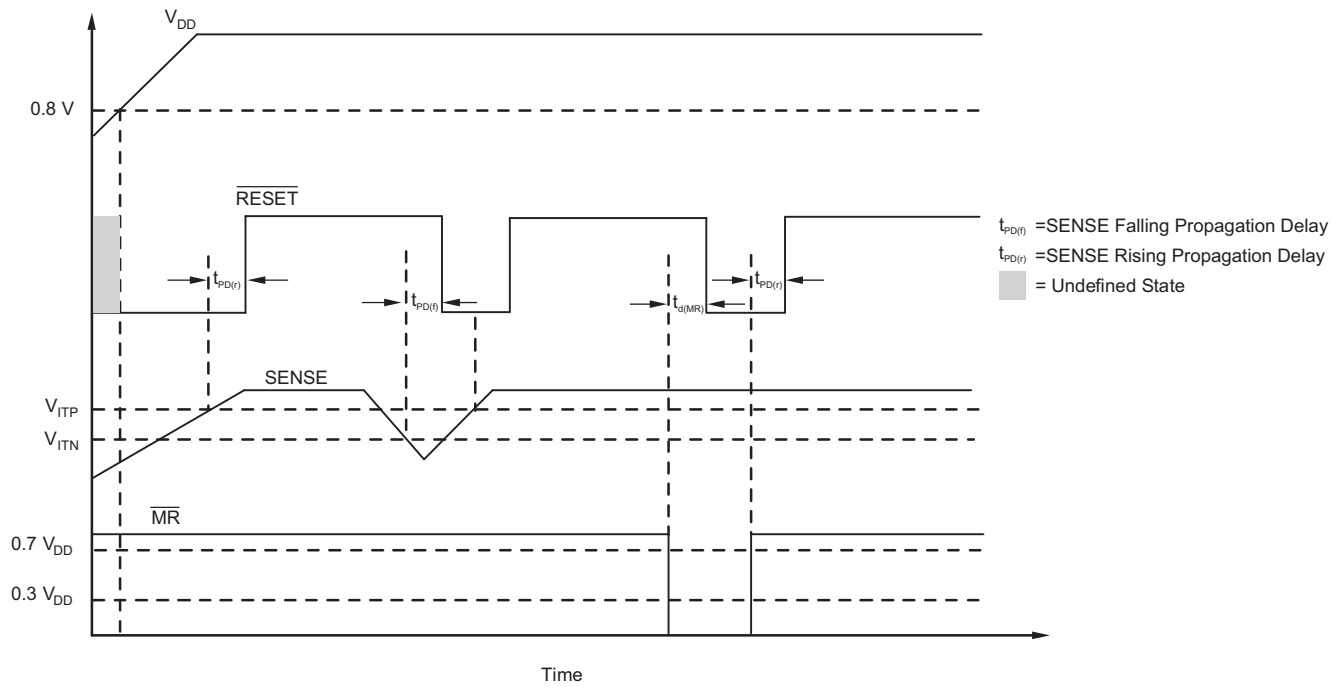


Figure 1. Timing Diagram

7.7 Typical Characteristics

over the operating junction temperature range of -40°C to $+125^{\circ}\text{C}$, $1.5\text{ V} \leq V_{\text{DD}} \leq 5.5\text{ V}$, and $\overline{\text{MR}} = V_{\text{DD}}$ (unless otherwise noted)

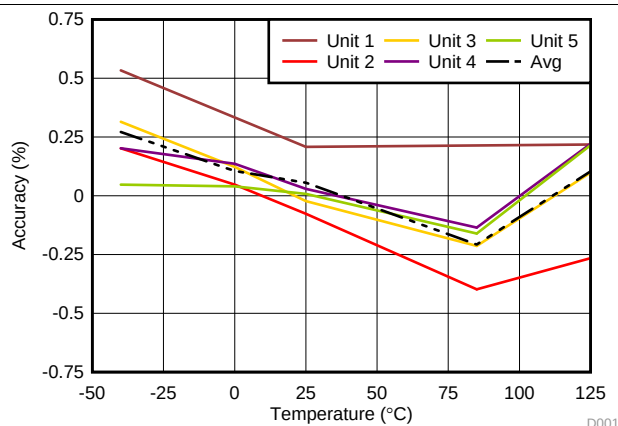


Figure 2. V_{ITN} Accuracy vs Temperature

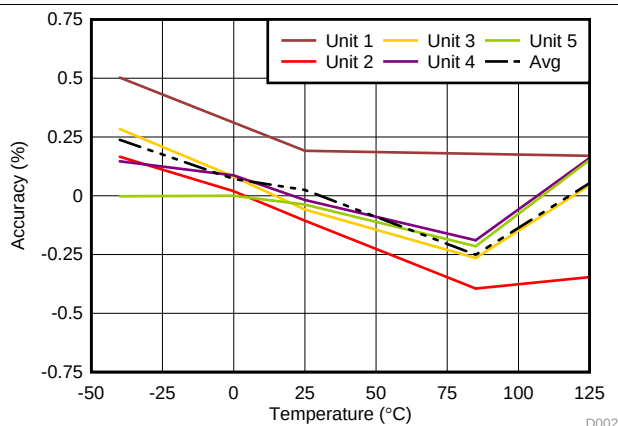
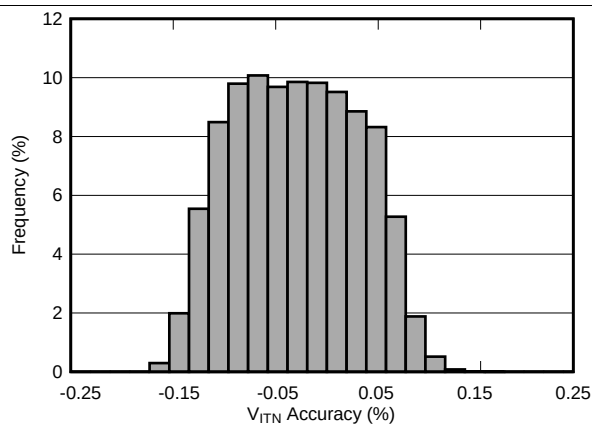
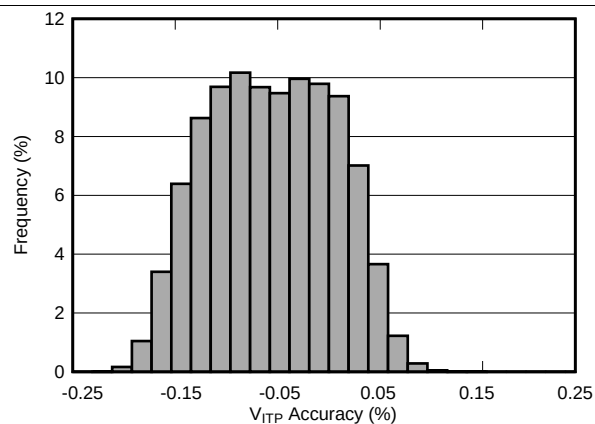


Figure 3. V_{ITP} Accuracy vs Temperature



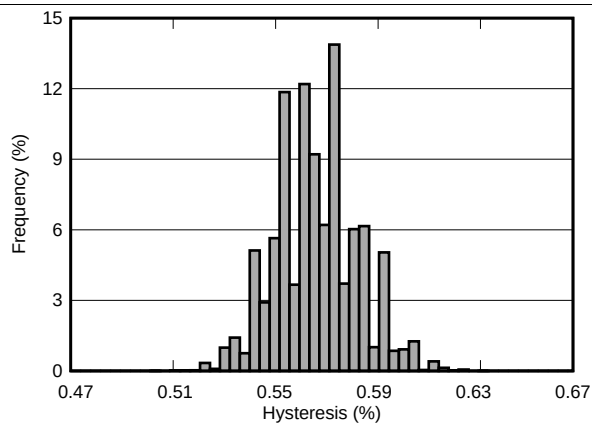
Tested at $V_{\text{DD}} = 1.5\text{ V}$ and $V_{\text{DD}} = 5.5\text{ V}$, total tests = 136,348

Figure 4. V_{ITN} Accuracy Histogram



Tested at $V_{\text{DD}} = 1.5\text{ V}$ and $V_{\text{DD}} = 5.5\text{ V}$, total tests = 136,348

Figure 5. V_{ITP} Accuracy Histogram



Tested at $V_{\text{DD}} = 1.5\text{ V}$ and $V_{\text{DD}} = 5.5\text{ V}$, total tests = 136,348

Figure 6. Hysteresis Histogram

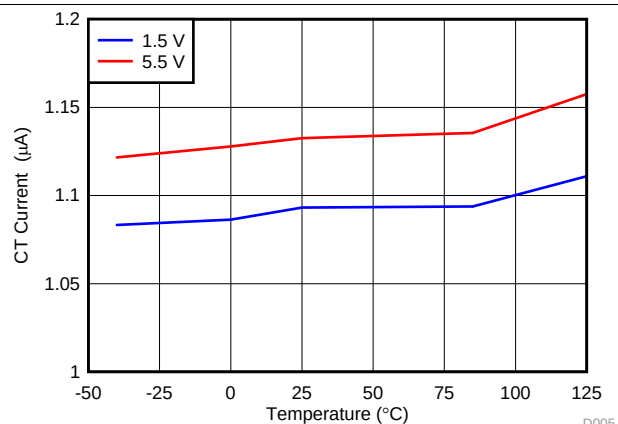


Figure 7. CT Current vs Temperature

Typical Characteristics (continued)

over the operating junction temperature range of -40°C to $+125^{\circ}\text{C}$, $1.5\text{ V} \leq V_{\text{DD}} \leq 5.5\text{ V}$, and $\overline{\text{MR}} = V_{\text{DD}}$ (unless otherwise noted)

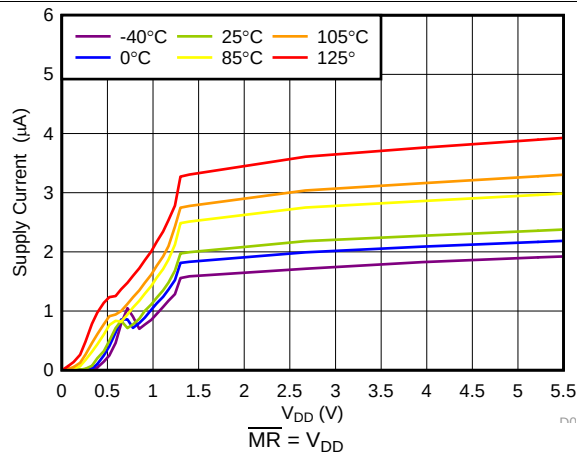


Figure 8. Supply Current vs Power-Supply Voltage

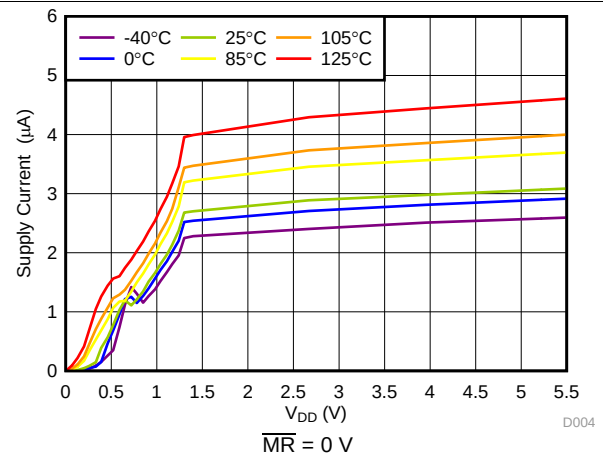


Figure 9. Supply Current vs Power-Supply Voltage

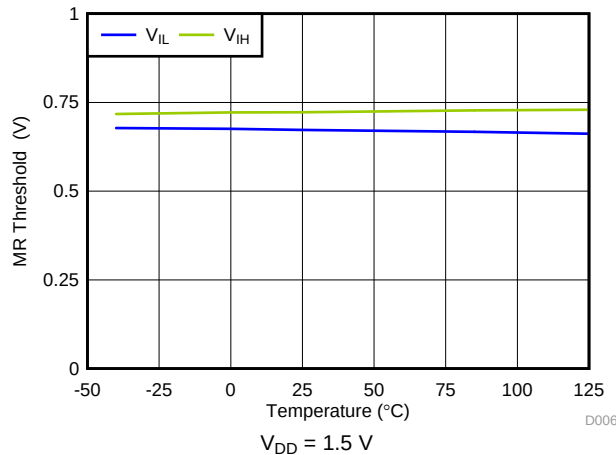


Figure 10. $\overline{\text{MR}}$ Threshold vs Temperature

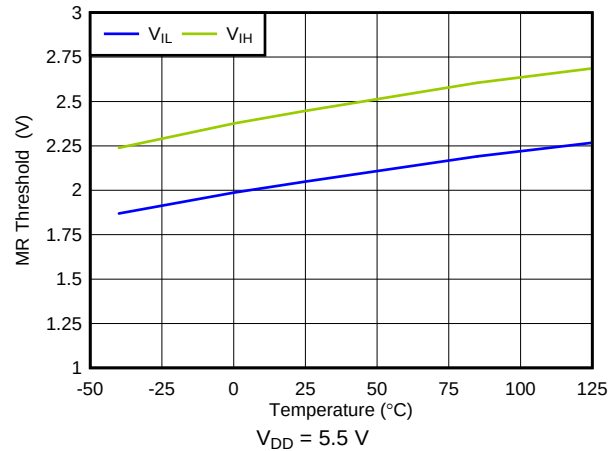


Figure 11. $\overline{\text{MR}}$ Threshold vs Temperature

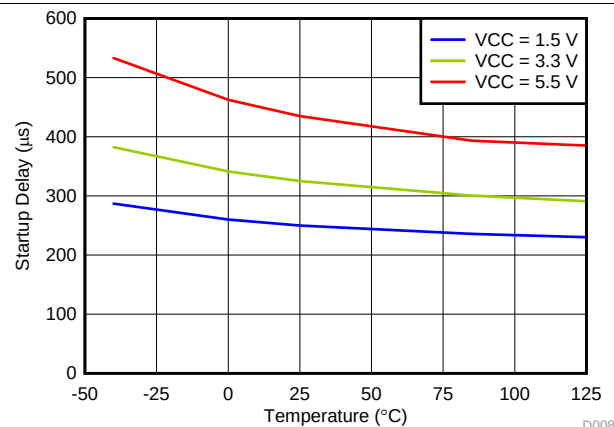


Figure 12. Startup Delay vs Temperature

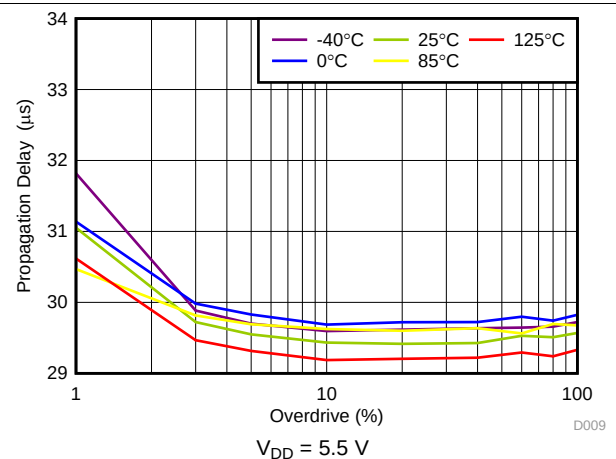


Figure 13. Propagation Delay ($t_{\text{PD}(r)}$) vs Overdrive

Typical Characteristics (continued)

over the operating junction temperature range of -40°C to $+125^{\circ}\text{C}$, $1.5\text{ V} \leq V_{\text{DD}} \leq 5.5\text{ V}$, and $\overline{\text{MR}} = V_{\text{DD}}$ (unless otherwise noted)

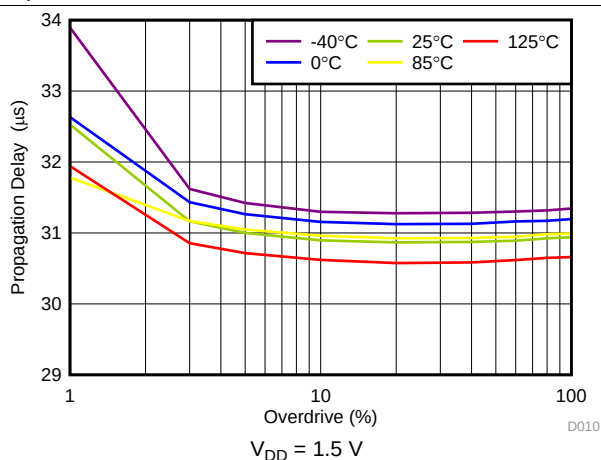


Figure 14. Propagation Delay ($t_{\text{PD}(f)}$) vs Overdrive

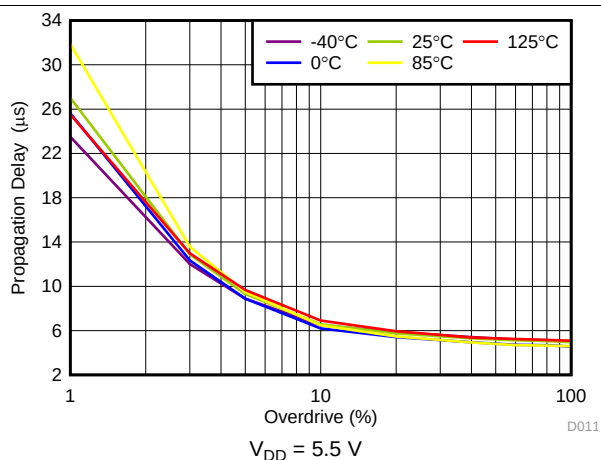


Figure 15. Propagation Delay ($t_{\text{PD}(f)}$) vs Overdrive

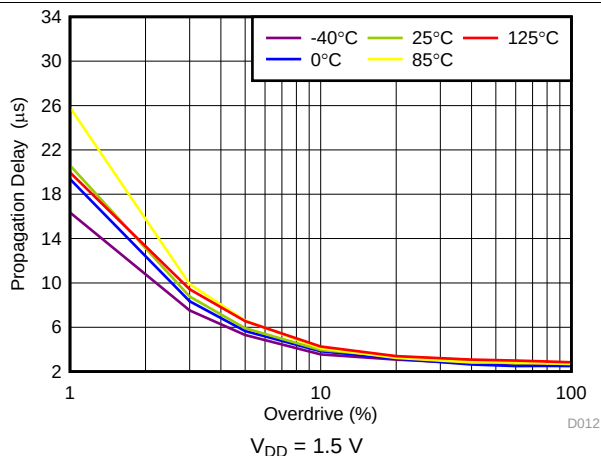


Figure 16. Propagation Delay ($t_{\text{PD}(f)}$) vs Overdrive

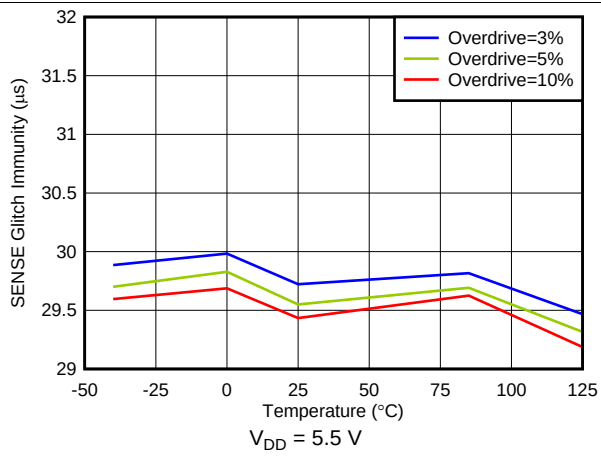


Figure 17. Low-to-High Glitch Immunity vs Temperature

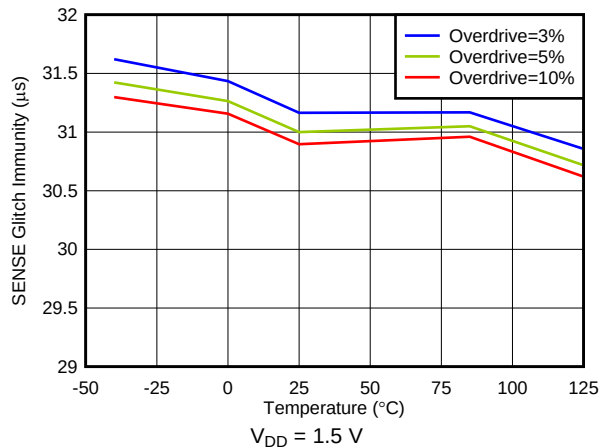


Figure 18. Low-to-High Glitch Immunity vs Temperature

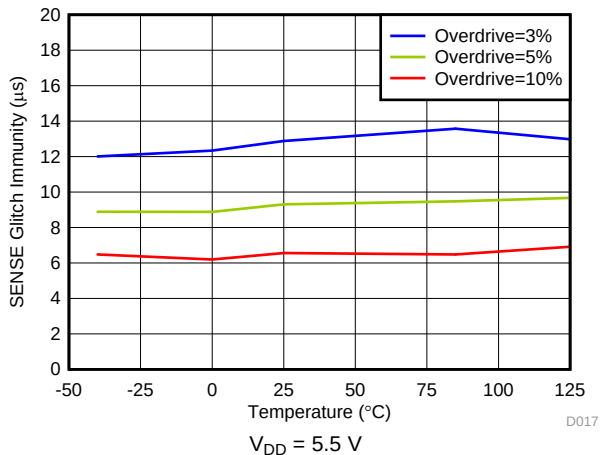


Figure 19. High-to-Low Glitch Immunity vs Temperature

Typical Characteristics (continued)

over the operating junction temperature range of -40°C to $+125^{\circ}\text{C}$, $1.5\text{ V} \leq V_{\text{DD}} \leq 5.5\text{ V}$, and $\overline{\text{MR}} = V_{\text{DD}}$ (unless otherwise noted)

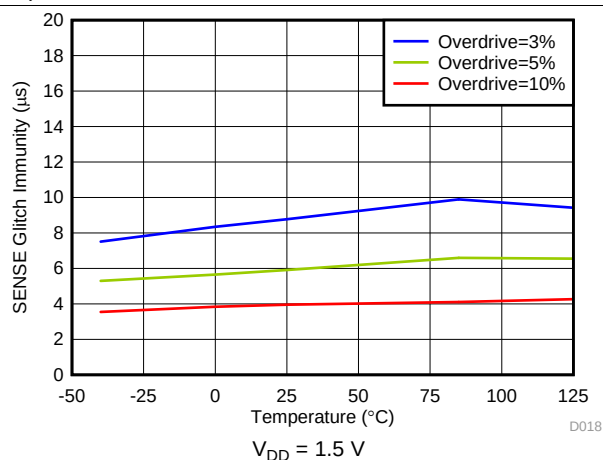


Figure 20. High-to-Low Glitch Immunity vs Temperature

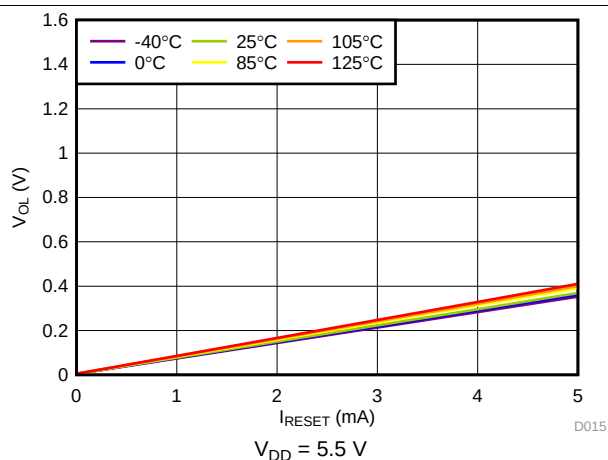


Figure 21. Low-Level Output Voltage vs RESET Current

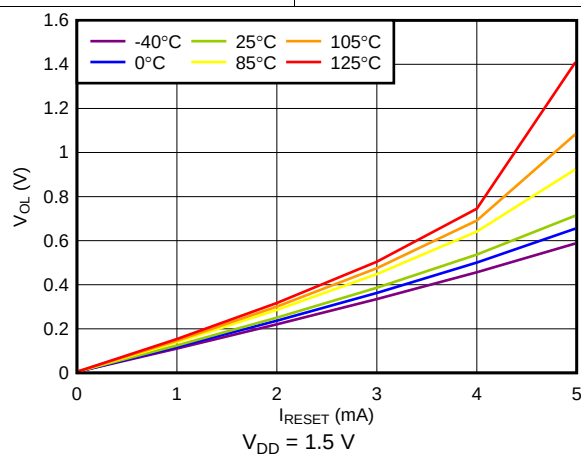


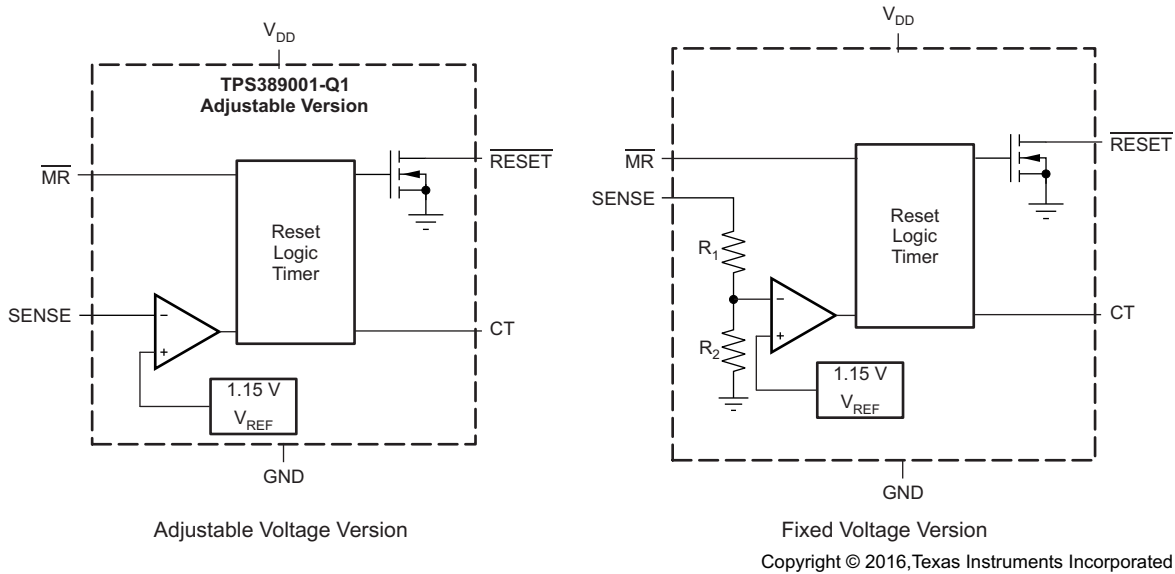
Figure 22. Low-Level Output Voltage vs RESET Current

8 Detailed Description

8.1 Overview

The TPS3890-Q1 supervisory product family is designed to assert a $\overline{\text{RESET}}$ signal when either the SENSE pin voltage drops below V_{ITN} or the manual reset ($\overline{\text{MR}}$) is driven low. The $\overline{\text{RESET}}$ output remains asserted for a user-adjustable time after both the manual reset ($\overline{\text{MR}}$) and SENSE voltages return above their respective thresholds.

8.2 Functional Block Diagram



8.3 Feature Description

The combination of user-adjustable reset delay time with a broad range of threshold voltages allow these devices to be used in a wide array of applications. Fixed negative threshold voltages (V_{ITN}) can be factory set from 1.15 V to 3.17 V (see the [Device Comparison Table](#) for available options), and the adjustable device can be used to customize the threshold voltage for other application needs by using an external resistor divider. The CT pin allows the reset delay to be set between 25 μs and 30 s with the use of an external capacitor.

8.3.1 User-Configurable $\overline{\text{RESET}}$ Delay Time

The rising $\overline{\text{RESET}}$ delay time ($t_{\text{PD}(r)}$) can be configured by installing a capacitor connected to the CT pin. The TPS3890-Q1 uses a CT pin charging current (I_{CT}) of 1.15 μA to help counter the effect of capacitor and board-level leakage currents that can be substantial in certain applications. The rising $\overline{\text{RESET}}$ delay time can be set to any value between 25 μs (no C_{CT} installed) and 30 s ($C_{\text{CT}} = 26\text{ }\mu\text{F}$).

The capacitor value needed for a given delay time can be calculated using [Equation 1](#):

$$t_{\text{PD}(r)} (\text{sec}) = C_{\text{CT}} \times V_{\text{CT}} \div I_{\text{CT}} + t_{\text{PD}(r)(\text{nom})} \quad (1)$$

The slope of [Equation 1](#) is determined by the time that the CT charging current (I_{CT}) takes to charge the external capacitor up to the CT comparator threshold voltage (V_{CT}). When $\overline{\text{RESET}}$ is asserted, the capacitor is discharged through the internal CT pulldown resistor (R_{CT}). When the $\overline{\text{RESET}}$ conditions are cleared, the internal precision current source is enabled and begins to charge the external capacitor and when the voltage on this capacitor reaches 1.22 V, $\overline{\text{RESET}}$ is deasserted. Note that in order to minimize the difference between the calculated $\overline{\text{RESET}}$ delay time and the actual $\overline{\text{RESET}}$ delay time, use a low-leakage type capacitor (such as a ceramic capacitor) and minimize parasitic board capacitance around this pin.

Feature Description (continued)

8.3.2 Manual Reset ($\overline{\text{MR}}$) Input

The manual reset ($\overline{\text{MR}}$) input allows a processor or other logic circuits to initiate a reset. A logic low on $\overline{\text{MR}}$ causes RESET to assert. After $\overline{\text{MR}}$ returns to a logic high and SENSE is above V_{ITP} , RESET is deasserted after the user-defined reset delay. If MR is not controlled externally, then MR must be connected to VDD. Note that if the logic signal driving $\overline{\text{MR}}$ is not greater than or equal to V_{DD} , then some additional current flows into VDD and out of MR and the difference is apparent when comparing Figure 8 and Figure 9.

Figure 23 shows how $\overline{\text{MR}}$ can be used to monitor multiple system voltages when only a single CT capacitor is needed to set the RESET delay time.

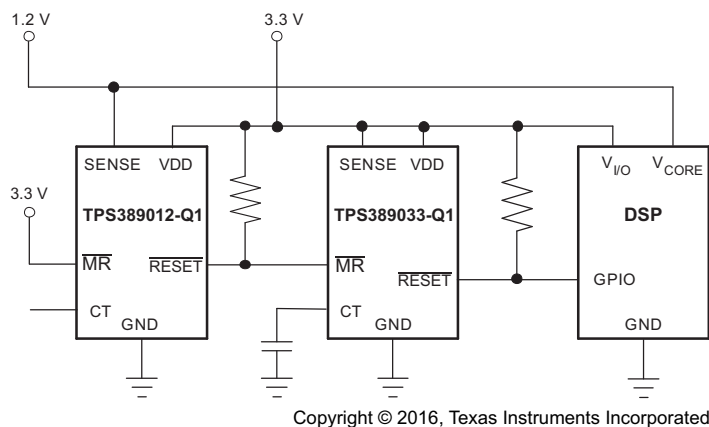


Figure 23. Using $\overline{\text{MR}}$ to Monitor Multiple System Voltages

8.3.3 RESET Output

RESET remains high (deasserted) as long as SENSE is above the positive threshold (V_{ITP}) and the manual reset signal (MR) is logic high. If SENSE falls below the negative threshold (V_{ITN}) or if MR is driven low, then RESET is asserted, driving the RESET pin to a low impedance.

When $\overline{\text{MR}}$ is again logic high and SENSE is above V_{ITP} , a delay circuit is enabled that holds RESET low for a specified reset delay period ($t_{\text{PD}(f)}$). When the reset delay has elapsed, the RESET pin goes to a high-impedance state and uses a pullup resistor to hold RESET high. Connect the pullup resistor to the proper voltage rail to enable the outputs to be connected to other devices at the correct interface voltage level. RESET can be pulled up to any voltage up to 5.5 V, independent of the device supply voltage. To ensure proper voltage levels, give some consideration when choosing the pullup resistor values. The pullup resistor value is determined by V_{OL} , the output capacitive loading, and the output leakage current ($I_{\text{LKG(OD)}}$).

8.3.4 SENSE Input

The SENSE input can vary from ground to 5.5 V (7.0 V, absolute maximum), regardless of the device supply voltage used. The SENSE pin is used to monitor the critical voltage rail. If the voltage on this pin drops below V_{ITN} , then RESET is asserted. When the voltage on the SENSE pin exceeds the positive threshold voltage, RESET deasserts after the user-defined RESET delay time.

The internal comparator has built-in hysteresis to ensure well-defined RESET assertions and deassertions even when there are small changes on the voltage rail being monitored.

The TPS3890-Q1 device is relatively immune to short transients on the SENSE pin. Glitch immunity is dependent on threshold overdrive, as illustrated in Figure 19 for V_{ITN} and Figure 18 for V_{ITP} . Although not required in most cases, for noisy applications good analog design practice is to place a 1-nF to 10-nF bypass capacitor at the SENSE input to reduce sensitivity to transient voltages on the monitored signal.

Feature Description (continued)

The adjustable version (TPS389001-Q1) can be used to monitor any voltage rail down to 1.15 V using the circuit shown in [Figure 24](#).

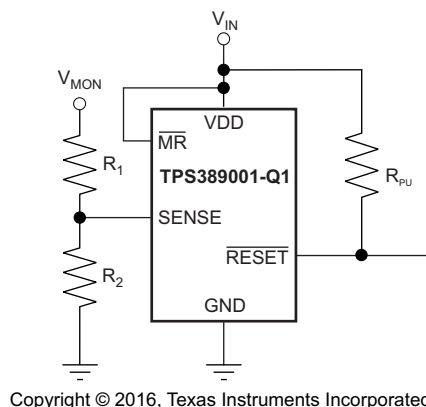


Figure 24. Using the TPS389001-Q1 to Monitor a User-Defined Threshold Voltage

The target threshold voltage for the monitored supply ($V_{ITX(MON)}$) and the resistor divider values can be calculated by using [Equation 2](#) and [Equation 3](#), respectively:

$$V_{ITX(MON)} = V_{ITX} \times (1 + R_1 \div R_2) \quad (2)$$

[Equation 3](#) can be used to calculate either the negative threshold or the positive threshold by replacing V_{ITX} with either V_{ITN} or V_{ITP} , respectively.

$$R_{TOTAL} = R_1 + R_2 \quad (3)$$

Resistors with high values minimize current consumption; however, the input bias current of the device degrades accuracy if the current through the resistors is too low. Therefore, choosing an R_{TOTAL} value so that the current through the resistor divider is at least 100 times larger than the SENSE input current is simplest. See the [Optimizing Resistor Dividers at a Comparator Input](#) application report for more details on sizing input resistors.

8.3.4.1 Immunity to SENSE Pin Voltage Transients

The TPS3890-Q1 is immune to short voltage transient spikes on the input pins. Sensitivity to transients depends on both transient duration and overdrive (amplitude) of the transient. Overdrive is defined by how much V_{SENSE} exceeds the specified threshold, and is important to know because the smaller the overdrive, the slower the response of the outputs (that is, undervoltage and overvoltage). Threshold overdrive is calculated as a percent of the threshold in question, as shown in [Equation 4](#).

$$\text{Overdrive} = | (V_{SENSE} / V_{ITX} - 1) \times 100\% | \quad (4)$$

[Figure 17](#) to [Figure 20](#) illustrate the glitch immunity that the TPS3890-Q1 has versus temperature with three different overdrive voltages. The propagation delay versus overdrive curves ([Figure 13](#) to [Figure 16](#)) can be used to determine how sensitive the TPS3890-Q1 family of devices are across an even wider range of overdrive voltages.

8.4 Device Functional Modes

Table 1 summarizes the various functional modes of the device.

Table 1. Truth Table

V_{DD}	$\overline{MR}$	SENSE	$\overline{RESET}$
$V_{DD} < V_{POR}$	—	—	Undefined
$V_{POR} < V_{DD} < V_{DD(MIN)}^{(1)}$	—	—	L
$V_{DD} \geq V_{DD(MIN)}$	L	—	L
$V_{DD} \geq V_{DD(MIN)}$	H	$V_{SENSE} < V_{ITN}$	L
$V_{DD} \geq V_{DD(MIN)}$	H	$V_{SENSE} > V_{ITP}$	H

(1) When V_{DD} falls below $V_{DD(MIN)}$, undervoltage-lockout (UVLO) takes effect and $\overline{RESET}$ is held low until V_{DD} falls below V_{POR} .

8.4.1 Normal Operation ($V_{DD} > V_{DD(min)}$)

When V_{DD} is greater than $V_{DD(min)}$, the $\overline{RESET}$ signal is determined by the voltage on the SENSE pin and the logic state of $\overline{MR}$.

- $\overline{MR}$ high: when the voltage on V_{DD} is greater than 1.5 V, the $\overline{RESET}$ signal corresponds to the voltage on the SENSE pin relative to the threshold voltage.
- $\overline{MR}$ low: in this mode, $\overline{RESET}$ is held low regardless of the voltage on the SENSE pin.

8.4.2 Above Power-On-Reset But Less Than $V_{DD(min)}$ ($V_{POR} < V_{DD} < V_{DD(min)}$)

When the voltage on V_{DD} is less than the $V_{DD(min)}$ voltage, and greater than the power-on-reset voltage (V_{POR}), the $\overline{RESET}$ signal is asserted regardless of the voltage on the SENSE pin.

8.4.3 Below Power-On-Reset ($V_{DD} < V_{POR}$)

When the voltage on V_{DD} is lower than V_{POR} , the device does not have enough voltage to internally pull the asserted output low and $\overline{RESET}$ is undefined and must not be relied upon for proper device function.

9 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The following sections describe in detail how to properly use this device, depending on the requirements of the final application.

9.2 Typical Application

A typical application for the TPS389018-Q1 is shown in [Figure 25](#). The TPS389018-Q1 can be used to monitor the 1.8-V VDD rail required by the [TI Delfino™](#) microprocessor family. The open-drain RESET output of the TPS389018-Q1 is connected to the XRS input of the microprocessor. A reset event is initiated when the VDD voltage is less than V_{ITN} or when MR is driven low by an external source.

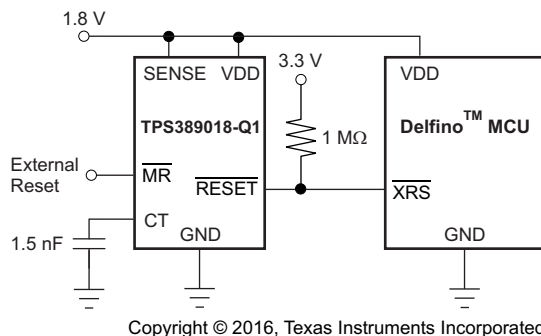


Figure 25. TPS3890-Q1 Monitoring the Supply Voltage for a Delfino Microprocessor

9.2.1 Design Requirements

The TPS3890-Q1 RESET output can be used to drive the reset ($\overline{XRS}$) input of a microprocessor. The RESET pin of the TPS3890-Q1 is pulled high with a 1-MΩ resistor; the reset delay time is controlled by the CT capacitor and is set depending on the reset requirement times of the microprocessor. During power-up, XRS must remain low for at least 1 ms after VDD reaches 1.5 V for the [C2000™ Delfino family of microprocessors](#). For 100-MHz operation, the Delfino [TMS320F2833x](#) microcontroller uses a supply voltage of 1.8 V that must be monitored by the TPS3890-Q1.

9.2.2 Detailed Design Procedure

The primary constraint for this application is choosing the correct device to monitor the supply voltage of the microprocessor. The TPS389018-Q1 has a negative threshold of 1.73 V and a positive threshold of 1.74 V, making the device suitable for monitoring a 1.8-V rail. The secondary constraint for this application is the reset delay time that must be at least 1 ms to allow the Delfino microprocessor enough time to startup up correctly. Because a minimum time is required, the worst-case scenario is a supervisor with a high CT charging current (I_{CT}) and a low CT comparator threshold (V_{CT}). For applications with ambient temperatures ranging from -40°C to $+125^{\circ}\text{C}$, C_{CT} can be calculated using $I_{CT(\text{Max})}$, $V_{CT(\text{Min})}$, and solving for C_{CT} in [Equation 1](#) such that the minimum capacitance required at the CT pin is 1.149 nF. If standard capacitors with $\pm 20\%$ tolerances are used, then the CT capacitor must be 1.5 nF or larger to ensure that the 1-ms delay time is met.

A 0.1-μF decoupling capacitor is connected to the VDD pin as a good analog design practice and a 1-MΩ resistor is used as the RESET pullup resistor to minimize the current consumption when RESET is asserted. The MR pin can be connected to an external signal if desired or connected to VDD if not used.

Typical Application (continued)

9.2.3 Application Curve

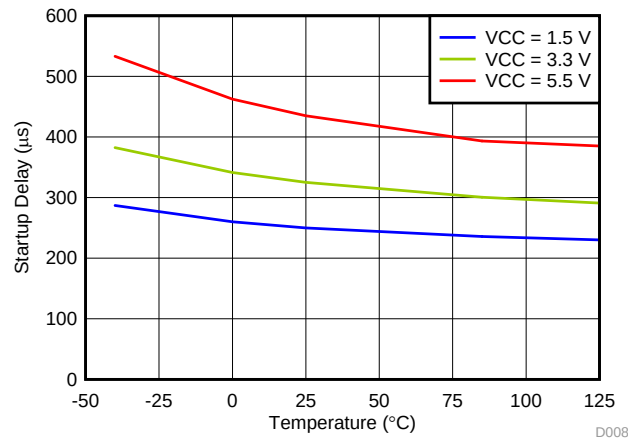


Figure 26. Startup Delay vs Temperature

10 Power Supply Recommendations

These devices are designed to operate from an input supply with a voltage range between 1.5 V and 5.5 V. An input supply capacitor is not required for this device; however, if the input supply is noisy, then good analog practice is to place a 0.1-μF capacitor between the VDD pin and the GND pin. This device has a 7-V absolute maximum rating on the VDD pin. If the voltage supply providing power to VDD is susceptible to any large voltage transient that can exceed 7 V, additional precautions must be taken.

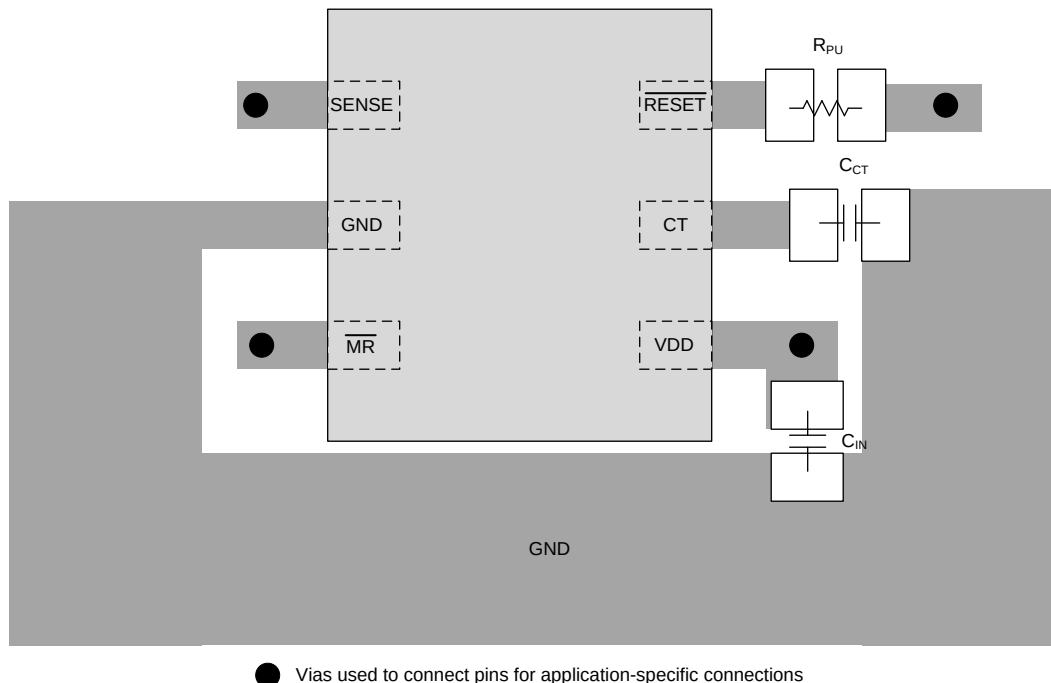
11 Layout

11.1 Layout Guidelines

Make sure that the connection to the VDD pin is low impedance. Good analog design practice is to place a 0.1- μ F ceramic capacitor near the VDD pin. If a capacitor is not connected to the CT pin, then minimize parasitic capacitance on this pin so the $\overline{\text{RESET}}$ delay time is not adversely affected.

11.2 Layout Example

The layout example in shows how the TPS3890-Q1 is laid out on a printed circuit board (PCB) with a user-defined delay.



● Vias used to connect pins for application-specific connections

Figure 27. Recommended Layout

12 Device and Documentation Support

12.1 Device Support

12.1.1 Device Nomenclature

Table 2 shows how to decode the function of the device based on the part number, with TPS389033G-Q1 used as an example.

Table 2. Device Naming Convention

DESCRIPTION	NOMENCLATURE	VALUE
TPS3890 (high-accuracy supervisor family)	—	—
33 (nominal rail voltage to be monitored)	10	1.0 V
	12	1.2 V
	18	1.8 V
	33	3.3 V
	50	5.0 V
G (percent below nominal rail voltage for V_{ITN})	—	4%
	G	7%
	K	11%
	L	12%
Q1 (automotive version)	—	—

12.2 Documentation Support

12.2.1 Related Documentation

For related documentation see the following:

- [Optimizing Resistor Dividers at a Comparator Input](#)
- [Sensitivity Analysis for Power Supply Design](#)
- [Getting Started With TMS320C28x Digital Signal Controllers](#)
- [TPS3890EVM-775 Evaluation Module User Guide](#)
- [C2000 Delfino Family of Microprocessors](#)
- [TMS320F2833x Digital Signal Controllers \(DSCs\)](#)

12.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.4 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

12.5 Trademarks

Delfino, C2000, E2E are trademarks of Texas Instruments.
All other trademarks are the property of their respective owners.

12.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.7 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS389001QDSERQ1	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	2N
TPS389001QDSERQ1.B	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	2N
TPS389012QDSERQ1	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	2O
TPS389012QDSERQ1.B	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	2O
TPS389015QDSERQ1	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	2P
TPS389015QDSERQ1.B	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	2P
TPS389018QDSERQ1	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	2Q
TPS389018QDSERQ1.B	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	2Q
TPS389025QDSERQ1	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	2R
TPS389025QDSERQ1.B	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	2R
TPS389030QDSERQ1	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	2S
TPS389030QDSERQ1.B	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	2S
TPS389033GQDSERQ1	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	7V
TPS389033GQDSERQ1.B	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	7V
TPS389033KQDSERQ1	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	7W
TPS389033KQDSERQ1.B	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	7W
TPS389033QDSERQ1	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	2T
TPS389033QDSERQ1.B	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	2T
TPS389050GQDSERQ1	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	7T
TPS389050GQDSERQ1.B	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	7T
TPS389050LQDSERQ1	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	7U
TPS389050LQDSERQ1.B	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	7U
TPS389050QDSERQ1	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	7S
TPS389050QDSERQ1.B	Active	Production	WSO (DSE) 6	3000 LARGE T&R	Yes	NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	7S

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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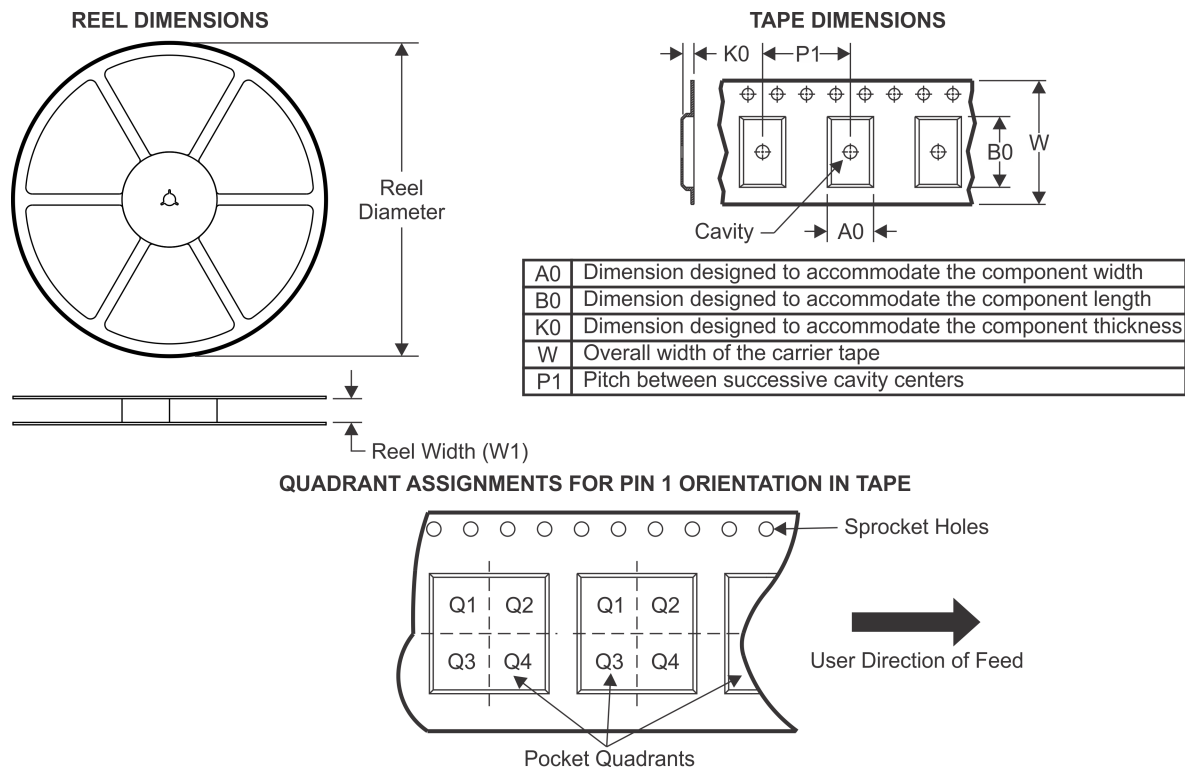
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF TPS3890-Q1 :

- Catalog : [TPS3890](#)

NOTE: Qualified Version Definitions:

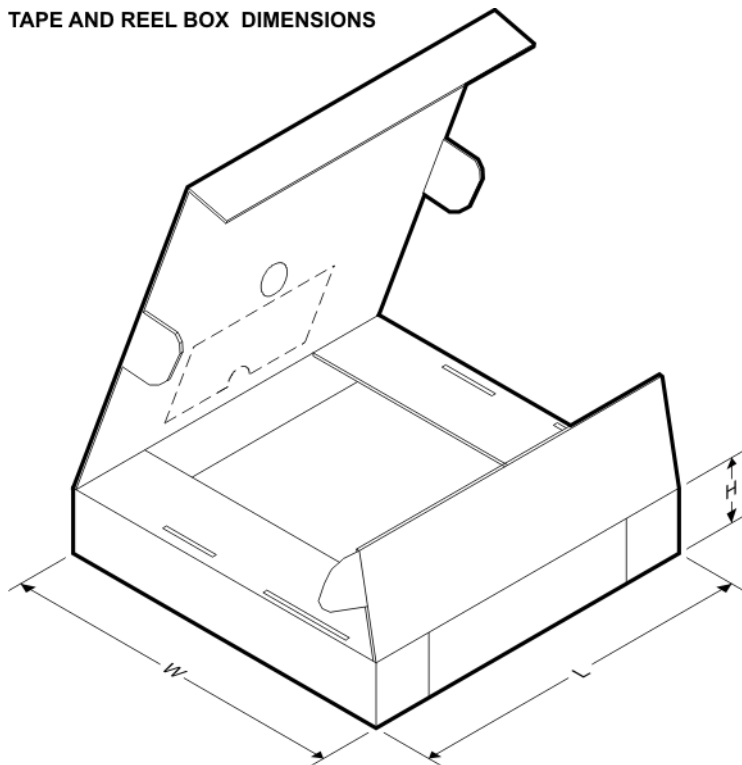
- Catalog - TI's standard catalog product

TAPE AND REEL INFORMATION


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS389001QDSERQ1	WSO	DSE	6	3000	180.0	8.4	1.83	1.83	0.89	4.0	8.0	Q2
TPS389012QDSERQ1	WSO	DSE	6	3000	180.0	8.4	1.83	1.83	0.89	4.0	8.0	Q2
TPS389015QDSERQ1	WSO	DSE	6	3000	180.0	8.4	1.83	1.83	0.89	4.0	8.0	Q2
TPS389018QDSERQ1	WSO	DSE	6	3000	180.0	8.4	1.83	1.83	0.89	4.0	8.0	Q2
TPS389025QDSERQ1	WSO	DSE	6	3000	180.0	8.4	1.83	1.83	0.89	4.0	8.0	Q2
TPS389030QDSERQ1	WSO	DSE	6	3000	180.0	8.4	1.83	1.83	0.89	4.0	8.0	Q2
TPS389033GQDSERQ1	WSO	DSE	6	3000	180.0	8.4	1.83	1.83	0.89	4.0	8.0	Q2
TPS389033KQDSERQ1	WSO	DSE	6	3000	180.0	8.4	1.83	1.83	0.89	4.0	8.0	Q2
TPS389033QDSERQ1	WSO	DSE	6	3000	180.0	8.4	1.83	1.83	0.89	4.0	8.0	Q2
TPS389050GQDSERQ1	WSO	DSE	6	3000	180.0	8.4	1.83	1.83	0.89	4.0	8.0	Q2
TPS389050LQDSERQ1	WSO	DSE	6	3000	180.0	8.4	1.83	1.83	0.89	4.0	8.0	Q2
TPS389050QDSERQ1	WSO	DSE	6	3000	180.0	8.4	1.83	1.83	0.89	4.0	8.0	Q2

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS389001QDSERQ1	WSN	DSE	6	3000	183.0	183.0	20.0
TPS389012QDSERQ1	WSN	DSE	6	3000	183.0	183.0	20.0
TPS389015QDSERQ1	WSN	DSE	6	3000	183.0	183.0	20.0
TPS389018QDSERQ1	WSN	DSE	6	3000	183.0	183.0	20.0
TPS389025QDSERQ1	WSN	DSE	6	3000	183.0	183.0	20.0
TPS389030QDSERQ1	WSN	DSE	6	3000	183.0	183.0	20.0
TPS389033GQDSERQ1	WSN	DSE	6	3000	183.0	183.0	20.0
TPS389033KQDSERQ1	WSN	DSE	6	3000	183.0	183.0	20.0
TPS389033QDSERQ1	WSN	DSE	6	3000	183.0	183.0	20.0
TPS389050GQDSERQ1	WSN	DSE	6	3000	183.0	183.0	20.0
TPS389050LQDSERQ1	WSN	DSE	6	3000	183.0	183.0	20.0
TPS389050QDSERQ1	WSN	DSE	6	3000	183.0	183.0	20.0

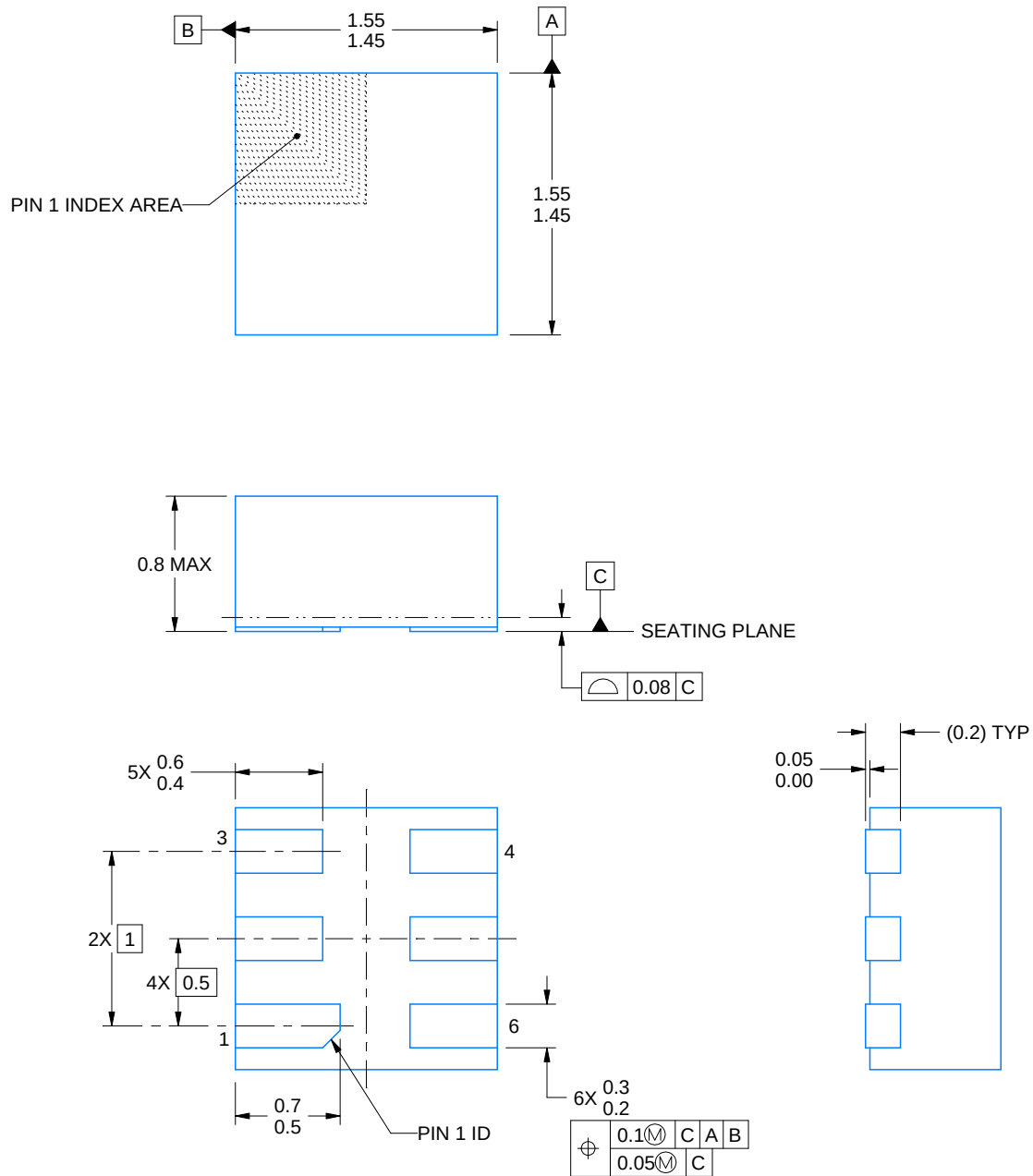
DSE0006A



PACKAGE OUTLINE

WSO - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



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NOTES:

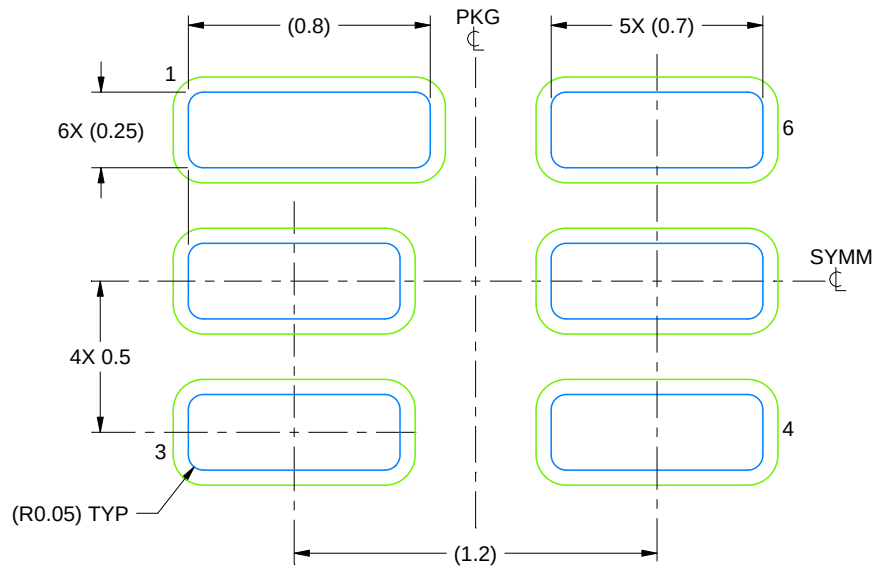
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

EXAMPLE BOARD LAYOUT

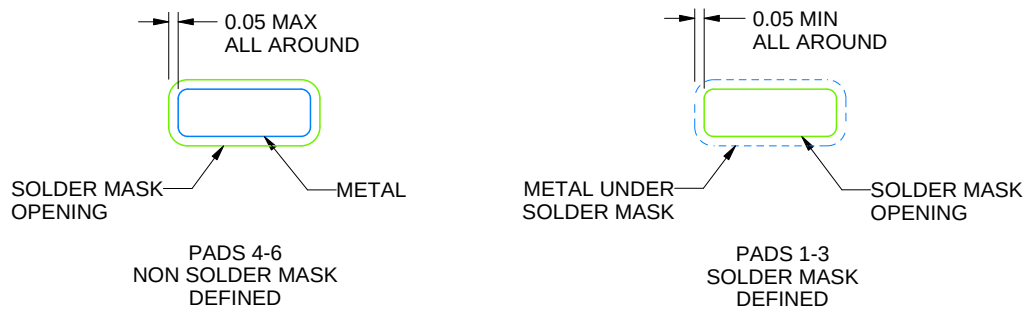
DSE0006A

WSN - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



LAND PATTERN EXAMPLE
SCALE:40X



SOLDER MASK DETAILS

4220552/B 01/2024

NOTES: (continued)

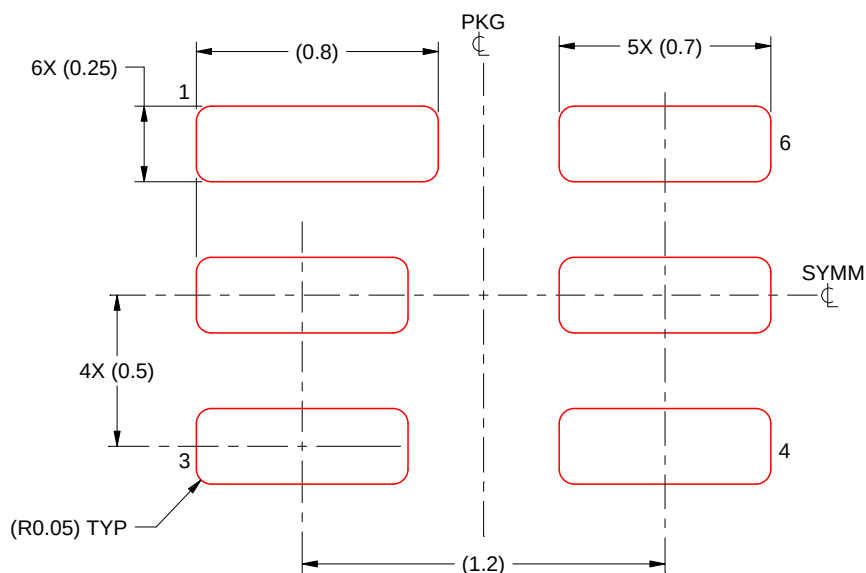
3. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

EXAMPLE STENCIL DESIGN

DSE0006A

WSN - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:40X

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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